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1c882 U.S. PTO

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December 20, 2001

Commissioner for Patents  
Washington, D.C. 20231

**Attorney Docket No. DKC 1800**

**RE: New Patent Application of LEE ET AL**

Enclosed herewith are the application papers for a patent in the name(s) of Shi-Choon Lee and Byung-Sun Kim entitled: "GLASS FIBER REINFORCED STYRENIC THERMOPLASTIC COMPOSITES CONTAINING AN AMINOSILANE COUPLING AGENT".

Enclosed are:

- Specification 16 pages
- Claims 1-18
- Abstract
- Declaration
- Application Data Sheet 3 pages
- Credit Card Payment Form for Filing Fee
- ✓ Assignment
- Recordation Cover Sheet
- Credit Card Payment Form for Recordation of Assignment

Filing Fee Calculation:

	Number Filed		Number extra		
Basic Filing Fee					\$ 740
Total Claims:	18	- 20	0	x \$18	0
Independent claims:	4	- 3	1	x \$84	84
Multiple dependent claims:				\$270	0
SUBTRACT ONE-HALF FOR SMALL ENTITY					0
TOTAL FILING FEE					\$ 824

Transmittal Letter for Patent Application for Lee  
December 20, 2001

Applicants claim the right of priority under 35 U.S.C. §119 to Republic of Korea Patent Application No. 2000-79156 filed on December 20, 2000. A certified copy is enclosed.

A prompt and favorable action on the merits is respectfully requested.

Respectfully submitted,



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